





Simulation of the high granularity readout TPC at CEPC Phy.&Det.TDR

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Motivation

dE/dx & dN/dx

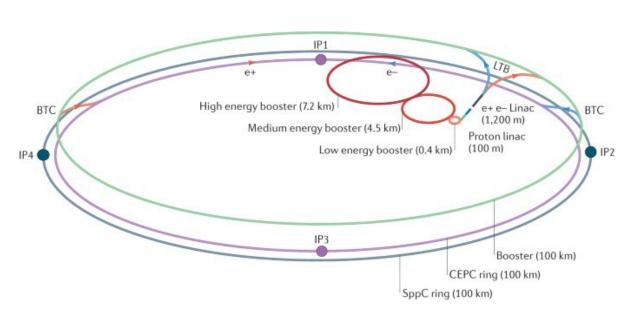
3 Simulation of pixel readout

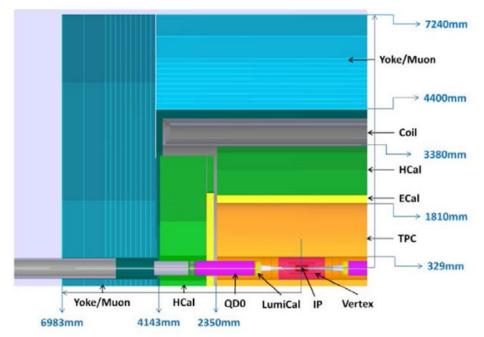
4 Summary

TPC technology for future e+e- Colliders

- Some advantages of TPC detector
 - Operation under 3&2 T magnetic field
 - A large number of 3D space points
 - Excellent pattern recognition capability
 - Ideal for 3D tracking and PID

- TPC detector plays a crucial role in the future e+e- Colliders
- A lot of R&D already present (LCTPC, CEPC TPC)

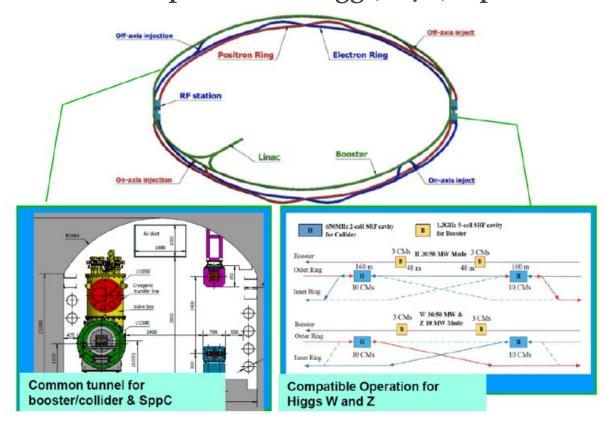


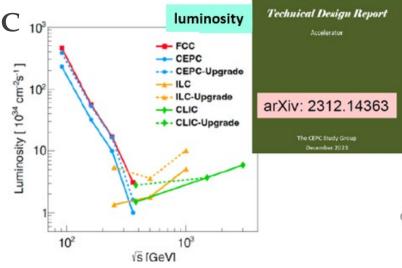


The structure of the baseline CEPC detector design

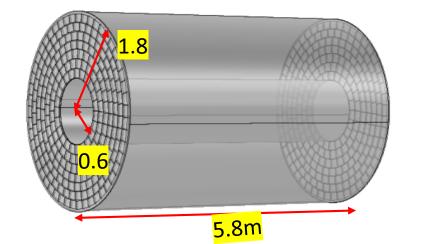
TPC at CEPC TDR Design

- Circular Collider: High luminosity than collider
- 100km circumference: Optium total cost, good also for Sppc
- Shared tunnel: Accommodate CEPC booster & collider and SppC 10°
- Swichable operation: Higgs, W/Z, top





CEPC



TPC requirements for e+e- Higgs/EW/Top factories

■ Provide decent #Hits (for track finding) with high spatial resolution compatible with PFA design

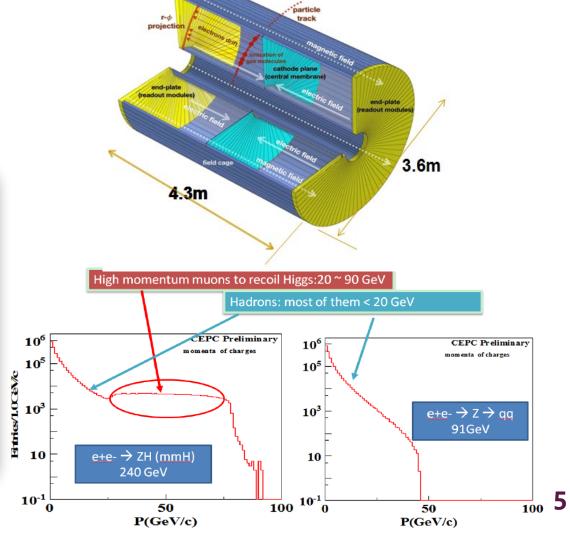
 $\sigma_{1/pt}$ ~10⁻⁴GeV/c⁻¹(TPC alone) and σ_{point} <100 μm

■ Provide dE/dx and dN/dx with a resolution < 3%

→ Effectively improve the Particle ID

Particle	(GeV)	Run Years	SR Power (MW)	Lumi./ IP (10 ³⁴ cm ⁻² s ⁻¹)	Integrated Lumi./ yr (ab ⁻¹ ,2 IPs)	Total Integrated L (ab-1,2 IPs)
Н	240	10	50	8.3	2.2	21.6
			30	5	13	13
Z	91	2	50	192	100	100
			30	115	60	60
W	160	1	50	26.7	6.9	6.9
			30	16	4.2	4.2
tī	360	5	50	0.8	1.0	1.0
			30	0.5	0.65	0.65

Latest CEPC Operation Plan from Yuhui Li on Monday



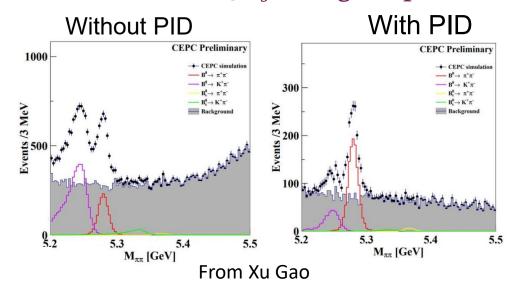
Particle Identification Requirements in TPC

- Physical Target
 - K/π separation power to be above 3σ at a Momentum of 20 GeV/c



- Improving jet Energy Resolution
- Beneficial for Flavor @ Z pole
 - → b-tagging (electrons from semi-leptonic b-decays)
 - → c-tagging, D meson spectroscopy (kaon/pion separation)

Simulation B⁰/B_s⁰ using Delphes

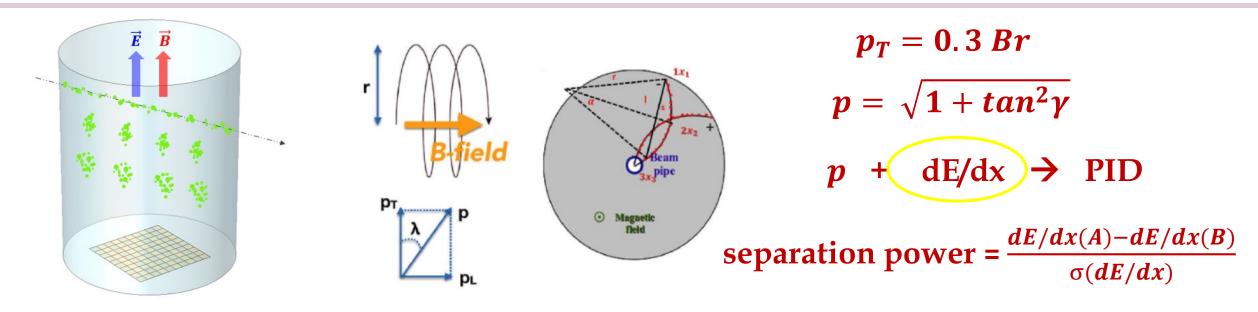


Requirements of TPC

Parameter			
Geometrical parameters	$egin{array}{lll} {\sf r}_{ m in} & {\sf r}_{ m out} & {\sf z} \\ {\sf 329} \ {\sf mm} & {\sf 1808} \ {\sf mm} & \pm \ {\sf 2350} \ {\sf mm} \end{array}$		
Solid angle coverage	up to $\cos heta \simeq 0.98$ (10 pad rows)		
TPC material budget	$\simeq~0.05~{ m X_0}$ including outer fieldcage in r		
	$<~0.25~{ m X}_0$ for readout endcaps in z		
Number of pads/timebuckets	$\simeq 1 ext{-}2 imes 10^6/1000$ per endcap		
Pad pitch/ no.padrows	$\simeq~1 imes$ 6 mm 2 for 220 padrows		
$\sigma_{ m point}$ in $r\phi$	$\simeq~60~\mu\mathrm{m}$ for zero drift, $<~100~\mu\mathrm{m}$ overall		
$\sigma_{ m point}$ in rz	$\simeq 0.4-1.4$ mm (for zero – full drift)		
2-hit resolution in $r\phi$	$\simeq 2$ mm		
2-hit resolution in ${\it rz}$	$\simeq 6$ mm		
dE/dx resolution	$\simeq 5$ %		
Momentum resolution at B=3.5 T	$\delta(1/p_t) \; \simeq \; 10^{-4}/\text{GeV/c} \; ext{(TPC only)}$		

dE/dx & dN/dx

Classical dE/dx Measurement



- Classical dE/dx measurement by charge (charge ≈ number of primary + secondary electrons)
- measure charge per sample along a track
- Long tail worsens the correlation of the measured average energy loss and the particle species
- the fundamental, central problem of all dE/dx measurements by charge summation



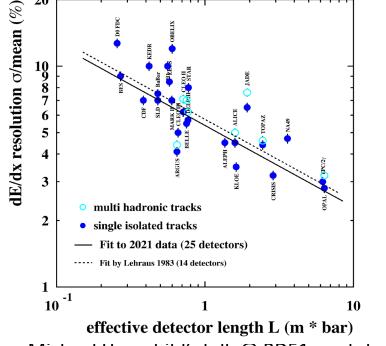


sensitive to large fluctuations

dN/dx Measurement by Cluster Counting

- Direct cluster counting \rightarrow ultimate way to measure dN/dx
 - avoid any problems with cluster fluctuations
 - no charge measurement need, just counting
 - < 3% dN/dx resolution by cluster counting (statistical error only)
 - 5.4% dE/dx resolution by charge measurement
 - Fit by Lehraus 1983: $dE/dx \text{ res.} = 5.7 * L^{-0.37} (\%)$
 - Fit in 2021: $dE/dx \text{ res.} = 5.4 * L^{-0.37} (\%)$

Obvious problem



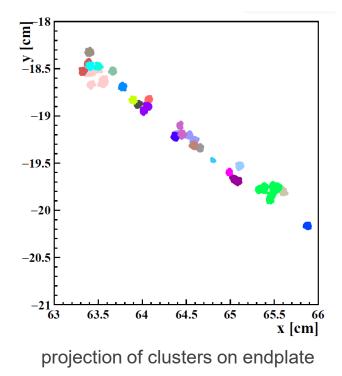
"Lehraus" Plot 2021*

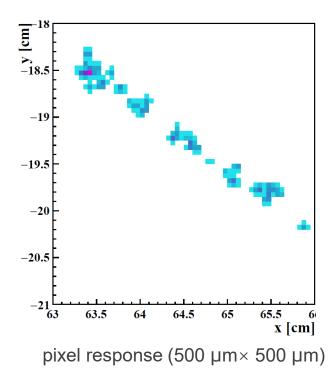
* From Michael Hauschild's talk @ RD51 workshop

- How to resolve individual clusters and count them?
 - high cluster density(\sim 30 cl./cm in Ar mixture for m.i.p \rightarrow typical drift velocities 50 µm/ns \rightarrow 6 \sim 10 ns in between clusters \rightarrow fast-shaping electronics (\sim ns needed) In time)
- Need devices with high time resolution or high granularity to resolve them

Cluster Counting in Space

- TPC with cluster counting
 - Cluster Counting so far based on time measurement in small drift cells
 - Pixel TPC makes space measurement possible
 - GEMs/Micromegas + small pixels have high granularity → resolve clusters in space
 - Time information added \rightarrow 3D position in space



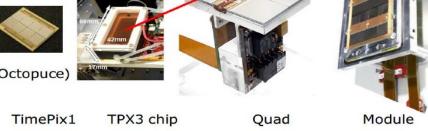


Application of Pixel Readout in LCTPC

■ GridPixes Pixel TPC Readout

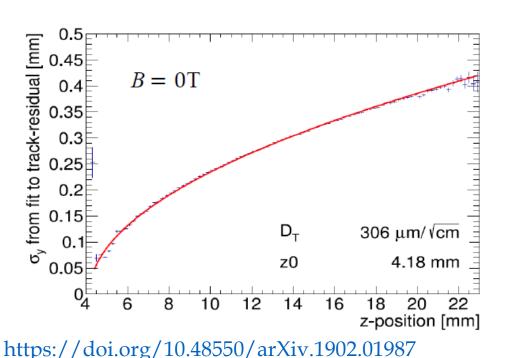
- Tests with single and quad devices have been successfully done.
- \sim 4.1% dE/dx resolution at B = 1.0T at DESY
- For very small readout pads the cluster counting method yields a (Octopuce)

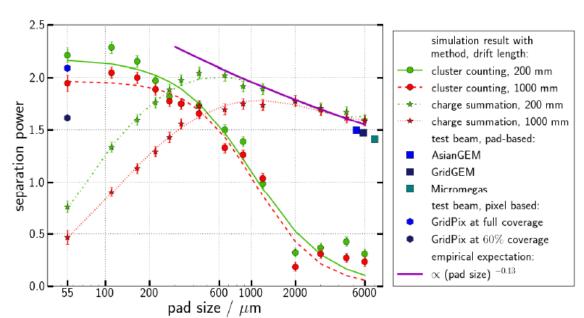
very good separation power



2018

2017





2007

https://doi.org/10.1088/1748-0221/17/11/P11027

2019

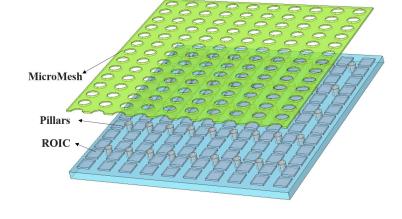
Application of Pixel Readout in CEPC-TPC

- Advantages of Pixel Readout for High Luminosity CEPC-TPC
 - High granularity readout allows measuring every ionization cluster
 - High spatial resolution under 2T or 3T magnetic field
 - **Better momentum resolution**
 - High-rate operation (MHz/cm²)
 - **Excellent two tracks separation performance**

- Performance
- **Optimization**
- Pixel size
- **Detector geometry**
- Occupancy
- Readout power consumption

Pad readout	Pixel readout		
Readout size : $2 \times 10 \text{ m}^2$	Readout size : $2 \times 10 \text{ m}^2$		
MPGD Readout	Micromegas Readout		
Single Pad size : $\geq 1 \text{mm} \times 6 \text{ mm}$	Single pixel size : $500 \mu m \times 500 \mu m$		
10 ⁶ readout units	10 ⁹ readout units		
dE/dx < 5%	dE/dx < 3%		
Rate: kHz/cm ²	Rate: MHz/cm ²		

Comparison of Two Readout Methods for CEPC-TPC

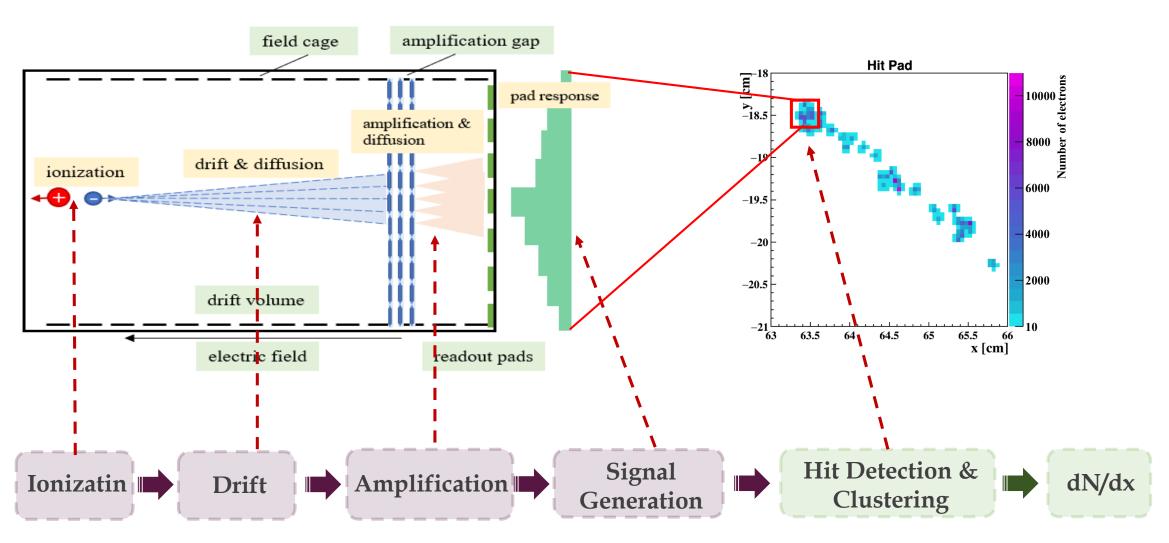


schematic diagram of a pixelated

readout structure

Simulation of pixel TPC

Full Simulation Framework of Pixel TPC

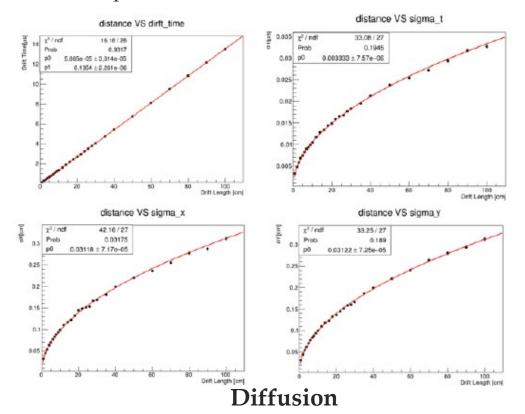


Simualtion / Digitization

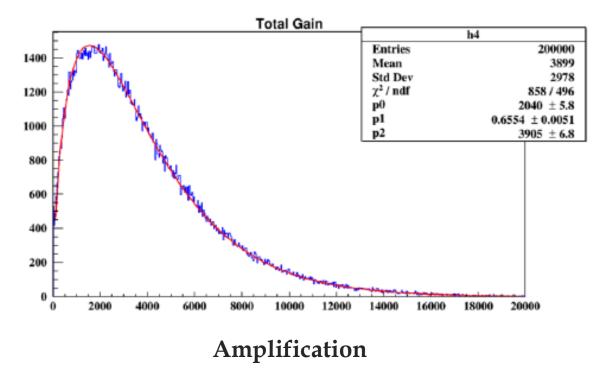
Reconstruction

Parametrizations

- To speed up the simulation, make several decompositions and apply parametrized models
- Electron diffusion:
 - σ_T vs drift distance
 - σ_X vs drift distance
 - σ_{Y} vs drift distance

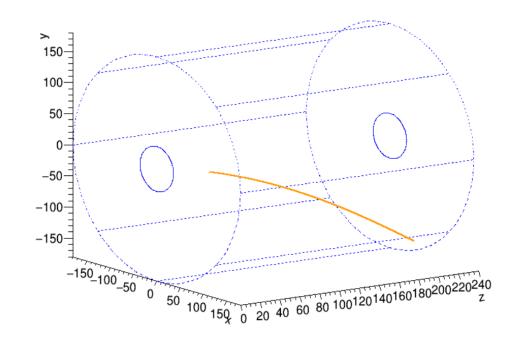


- Amplification:
 - Polyafunction sampling
- Signal generation
 - Double-Gaussian sampling

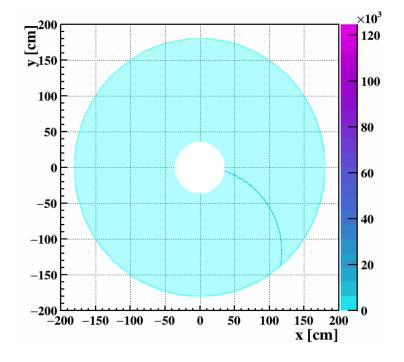


Simulation setup

- Magnetic field: 2T (Z-pole run)
- **Gas mixture:** T2K (Ar/CF₄/iC₄H₁₀: 95/3/2)
- Detector Layout : R (0.6 m 1.8 m); L (2.9 m)



A track of 1 GeV/c pion in TPC



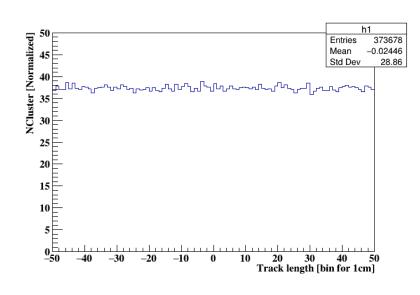
Projection of the same track on endplate

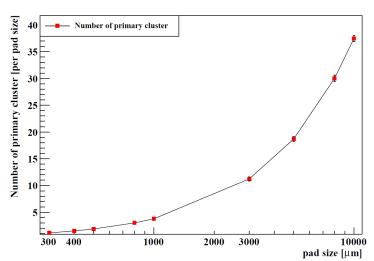
Simulation of the primary cluster

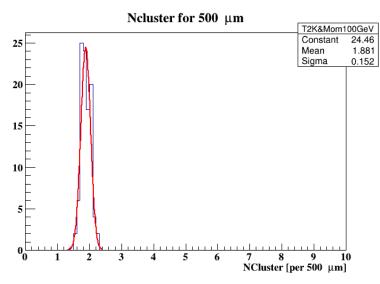
- Heed Simulation
- The distribution of clusters is uniform along the track
- Typically ~30 primary ionization clusters/cm in gas at 1 bar → T2K:37.4cluster/cm
- \sim 1.9 clusters/ 500 μ m , \sim 1.2 clusters/ 300 μ m

More detailed research is needed

• If pixel size is at the level of cluster distances of primary ionization, Cluster counting becomes effective



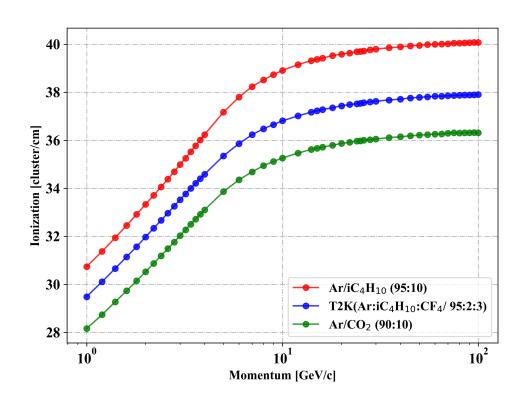


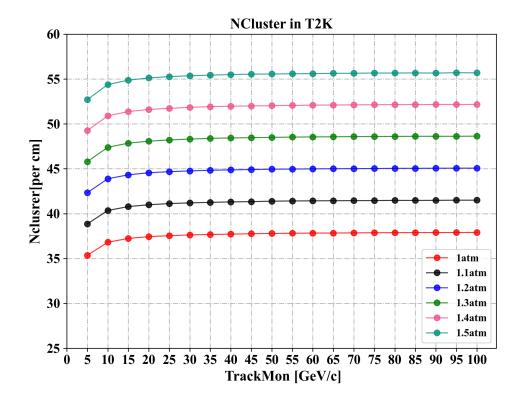


Pad size = 500 um Ncluster/cm

Simulation of the primary cluster

- Simulation Study for 1 m tracks in T2K gas with different particles different gas & pressure
 - Need gas with low diffusion & large drift velocity
 - Need gas with good cluster statistic
 - Pixel size → Optimize working gas & pressure

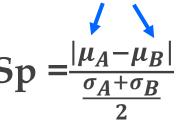


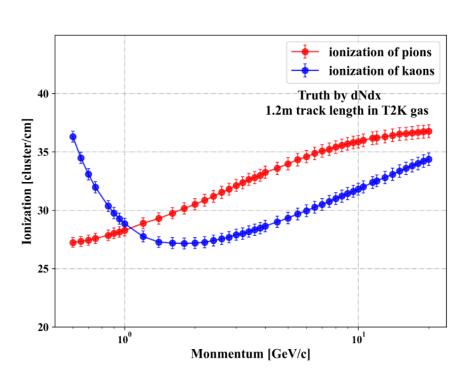


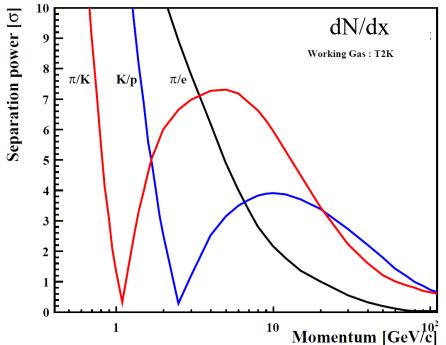
Particle Separation from MC Truth

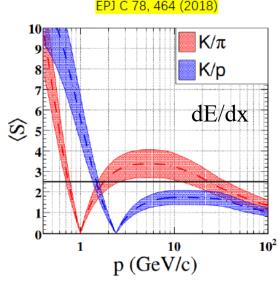
- Simulating pion/muon/kaon within [0.1-100] GeV/c in T2K gas
- The performance of particle separation is proportional to the difference in the average ionization
- The relative ionization of different particle species depends on the momentum
- Cluster counting exhibits excellent potential for particle identification

Number of Primary Ionization Clusters per **Unit Distance**





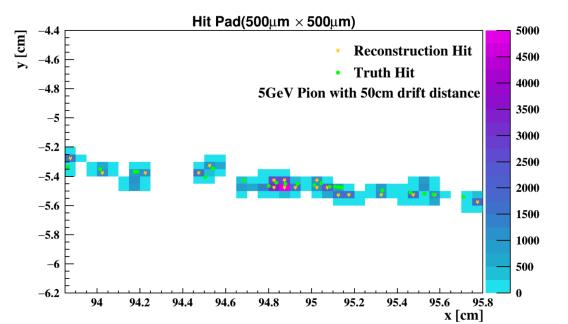


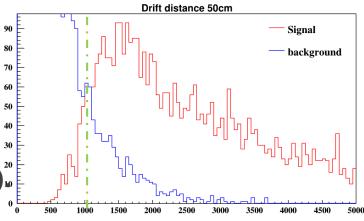


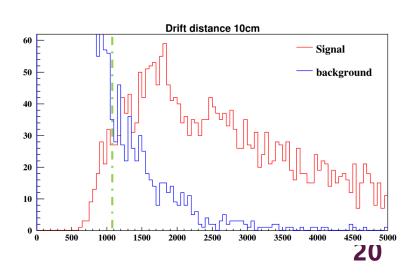
Averaged separation power of dE/dx in hadronic decays at the Z-pole

Preliminary Cluster Reconstruction

- By using a threshold-based method, preliminary reconstruction of clusters can be achieved
- The drift distance does not affect the threshold setting
- The reconstruction efficiency is related to the particle drift distance and requires calibration. (The reconstruction efficiency is 90% when the drift distance is 100 cm, and 60% when the drift distance is 50 cm)

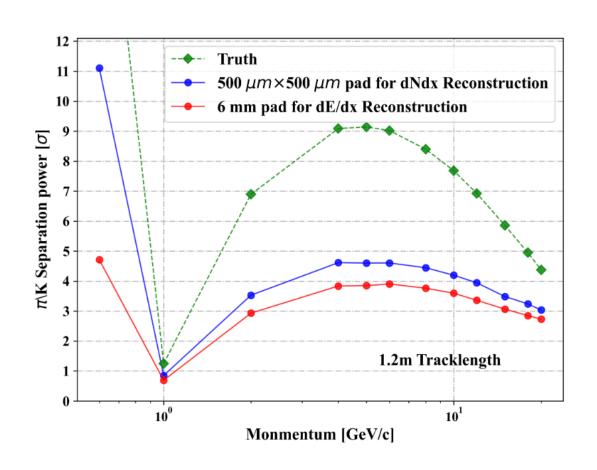


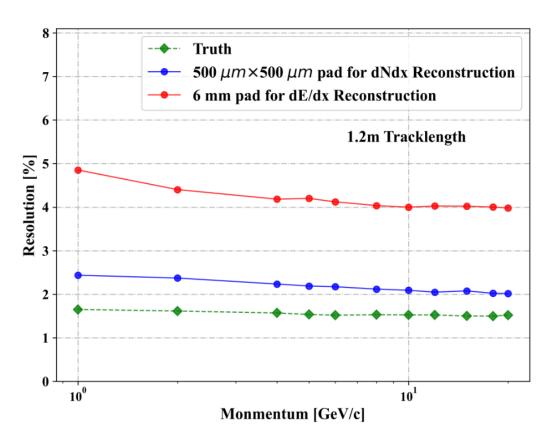




Preliminary PID Performance

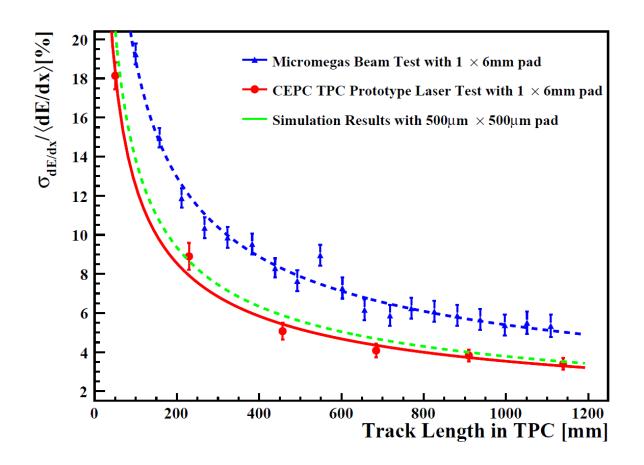
- Investigating the π/K discrimination capability using reconstructed clusters, a 3σ separation at 20GeV with a 50cm drift distance can be achieved
- dN/dx has significant potential for improving resolution



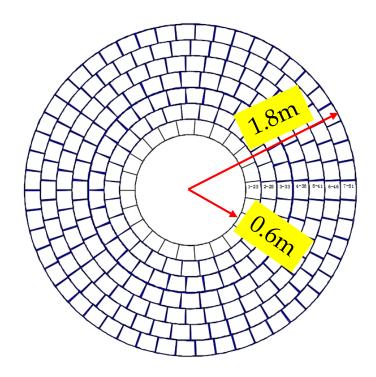


Preliminary dE/dx Performance

- A higher granularity is also very helpful for improving dE/dx.
- According to simulation results, for a pad size of 500um, with the current 1.2-meter track length of CEPC, the dE/dx can reach 3.2%.

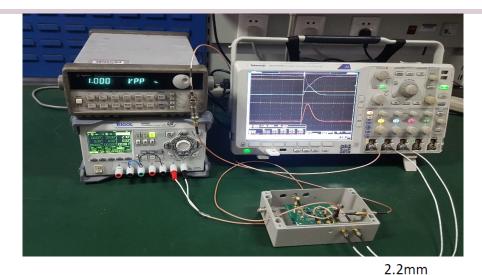


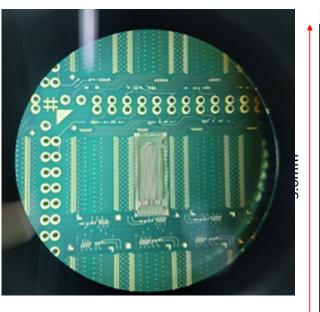
$$\sigma_{dE/dx} \sim L^{-0.47} \times G^{-0.13}$$

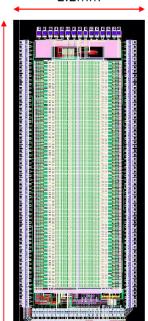


Current R&D effort

- R&D on pixel TPC readout for CEPC
- Pixel TPC ASIC chip was started to develop in 2023 and 1st prototype wafer standalone tested in May.
 - ✓ Power consumption: <1.1mW/ch (1st prototype)
 - ✓ <400mW/cm² (Test)
- 2nd prototype wafer design done
 - ✓ < 100mW/cm² (Goal and final design)
- The TOA and TOT can be selected as the initiation function in the ASIC chip.







Summary

- Classical PID with dE/dx by TPC charge measurement contributes to many large detectors
 - 5.4% typical dE/dx resolution for 1m track → no miracles to be expected
- Preliminary study show much better PID performance with cluster counting
 - 3o separation at 20GeV can be achieved
- The pixel readout is an efficient way to count every cluster in space
 - Further simulations are still necessary to understand the detailed requirements of the pixel detector(e.g. More realistic simulation model; More sophisticated reconstruction; Detector optimization etc.)
 - Pixel R&D is also ongoing currently, with the first prototype wafer undergoing standalone testing in May.
 - This work will contribute to the upcoming release of the CEPC TDR in 2024.
 - new ideas are also welcome

THANKS!